



PI6C100

Precision Clock Synthesizer
for Desktop PC's

Features

- Four copies of CPU clock with V_{DD} of 2.5V + 5%
- 100 MHz or 66 MHz operation
- Eight copies of PCI clock, (synchronous with CPU clock) 3.3V
- Two copies of IO APIC clock @14.31818 MHz
- Two copies of 48 MHz clock
- Three copies of Ref. clock @14.31818 MHz(3.3V TTL)
- Low cost 14.31818 MHz crystal oscillator input
- Spread spectrum modulation of CPU and PCI clocks for reduced EMI
- Power management control
- Isolated core V_{DD} , V_{SS} pins for noise reduction
- 48-pin SSOP package (V48)

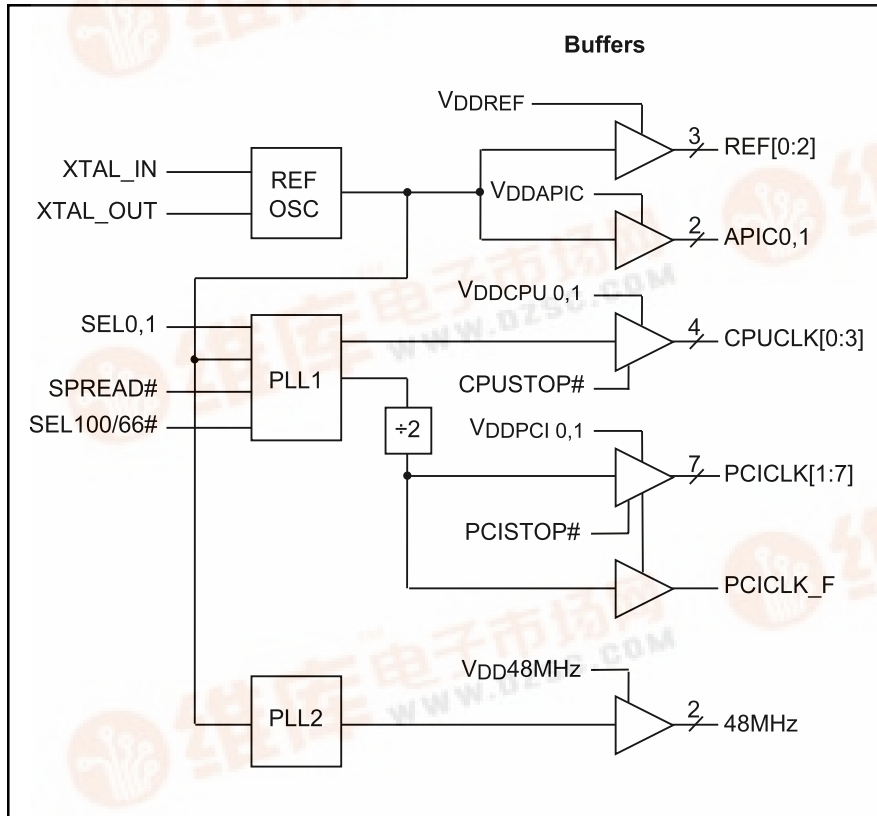
Description

The PI6C100 is a high-speed low-noise clock generator designed to work with the PI6C180 clock buffer to meet all clock needs for Intel Architecture platforms. CPU and chipset clock frequencies of 66.6 MHz and 100 MHz are supported.

Split supplies of 3.3V and 2.5V are used. The 3.3V power supply powers a portion of the I/O and the core. The 2.5V is used to power the remaining outputs. 2.5V signaling follows JEDEC standard 8-X. Power sequencing of the 3.3V and 2.5V supplies is not required.

An asynchronous PWRDWN# signal may be used to orderly power down (or up) the system.

Block Diagram



Pin Configuration

REF0	1	48	VDDREF
REF1	2	47	REF2
VSSREF	3	46	VDDAPIC
XTAL_IN	4	45	APIC0
XTAL_OUT	5	44	APIC1
VSSPCIO	6	43	VSSAPIC
PCICLK_F	7	42	NC
PCICLK1	8	41	VDDCPU0
VDDPCIO	9	40	CPUCCLK0
PCICLK2	10	39	CPUCCLK1
PCICLK3	11	38	VSSCPU0
VSSPC1	12	37	VDDCPU1
PCICLK4	13	36	CPUCCLK2
PCICLK5	14	35	CPUCCLK3
VDDPC1	15	34	VSSCPU1
PCICLK6	16	33	VDDCORE1
PCICLK7	17	32	VSSCORE1
VSSPC2	18	31	PCISTOP#
VDDCORE0	19	30	CPUCSTOP#
VSSCORE0	20	29	PWRDWN#
VDD48MHz	21	28	SPREAD#
48MHz	22	27	SEL0
48MHz	23	26	SEL1
Vss48MHz	24	25	SEL100/66#



Pin Description

Pin	Signal Name	Type	Qty.	Description
1,2,47	REF[0:2]	O	3	14.318 MHz clock output.
3	VSSREF	ground	1	Ground for REF[0:2] outputs
48	VDDREF	power	1	Power for REF[0:2] outputs
4	XTAL_IN	I	1	14.318 MHz crystal input.
5	XTAL_OUT	O	1	14.318 MHz crystal output.
6,12,18	VSSPCI[0:2]	ground	3	Ground for PCI clock outputs
7	PCICLK_F	O	1	Free running PCI clock output
9,15	VDDPCI[0:1]	power	2	Power for PCI clock outputs
8,10,11,13, 14,16,17	PCICLK[1:7]	O	7	PCI clock outputs, TTL compatible 3.3V
19,33	VDDCORE[0:1]	power	2	Isolated power for core
20,32	VSSCORE[0:1]	ground	2	Isolated ground for core
21	VDD48MHz	power	1	Isolated power for 48 MHz outputs
24	VSS48MHz	ground	1	Isolated ground for 48 MHz outputs
22,23	48MHz	O	2	48 MHz outputs
26,27	SEL[0:1]	I	2	Logic select pins. LVTTTL levels
25	SEL100/66#	I	1	Select pin for enabling 100 MHz or 66 MHz H = 100 MHz L = 66 MHz
29	PWRDWN#	I	1	Powers down device when held LOW
30	CPUSTOP#	I		Stops CPU clocks LOW if held LOW
31	PCI_STOP#	I	1	Stops PCI clocks LOW if held LOW
37,41	VDDCPU[0:1]	power	2	Power for CPU outputs
34,38	VSSPCU[0:]	ground	2	Ground for CPU outputs
35,36,39,40	CPUCLK[0:3]	O	4	CPU and Host clock outputs 2.5V
43	VSSAPIC	ground	1	Ground for APIC outputs
46	VDDAPIC	power	1	Power for APIC outputs
44,45	APIC[0:1]	O	2	APIC outputs @2.5V. 14.31818 MHz
28	SPREAD#	I	1	Enables Spread Spectrum feature when LOW
42	NC	—	1	Reserved for future modification



Select Functions

SEL100/66#	SEL1	SEL0	Function
0	0	0	Hi-Z
0	0	1	Reserved
0	1	0	Reserved
0	1	1	66 MHz active
1	0	0	Test mode
1	0	1	Reserved
1	1	0	Reserved
1	1	1	100 MHz active

Function Description	Outputs				
	CPU	PCI, PCI F	48MHz	REF[0:2]	IOAPIC
Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Hi-Z
Test Mode	TCLK/2	TCLK/6	TCLK/2	TCLK	TCLK

Note:

TCLK is a test clock over driven on the XTAL_IN input during test mode.

Clock Enable Configuration

CPU_STOP#	PCI_STOP#	PWR_DWN#	CPUCLK	PCICLK	Other Clocks	Crystal	VCO's
X	X	0	low	low	Stopped	off	off
0	0	1	low	low	running	running	running
0	1	1	low	33 MHz	running	running	running
1	0	1	100/66 MHz	low	running	running	running
1	1	1	100/66 MHz	33 MHz	running	running	running



CPU_STOP# is an input signal used to turn off the CPU clocks for low power operation. CPU_STOP# is asserted asynchronously by the external clock control logic with the rising edge of free running PCI clock and is internally synchronized to the external PCICLK_F output.

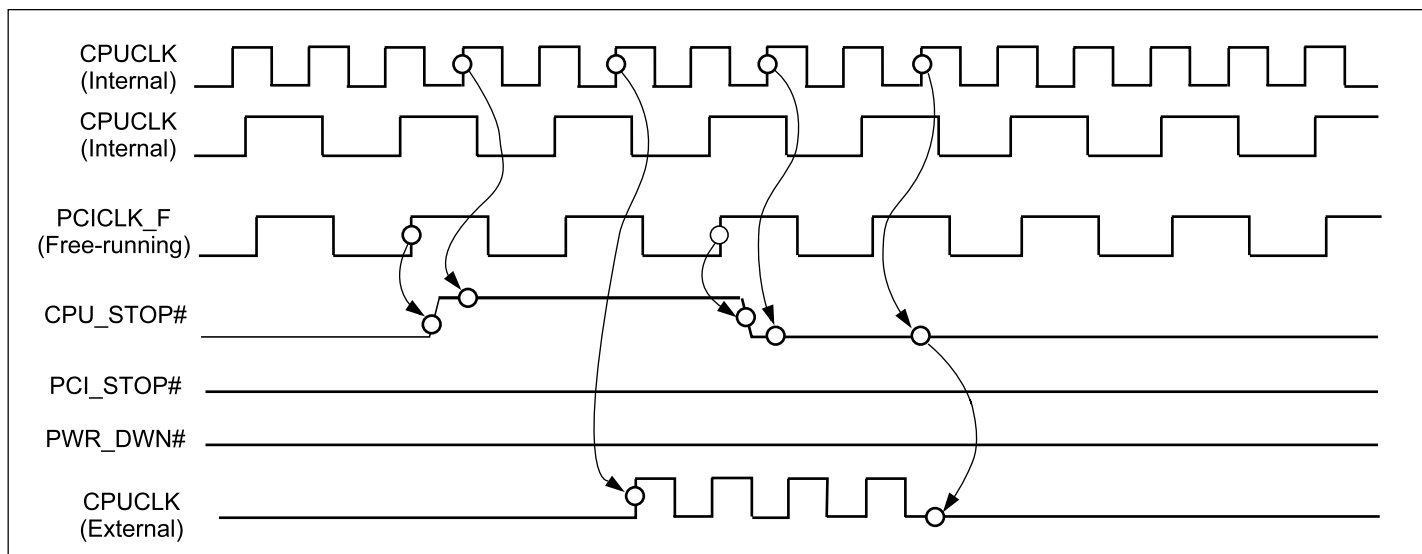
All other clocks continue to run while the CPU clocks are disabled. The CPU clocks are always stopped in a low state and started guaranteeing that the high pulse width is a full pulse. CPU clock on latency is 2 or 3 CPU clocks and CPU clock off latency is 2 or 3 CPU clocks.

Power Management Timing

Signal	Signal State	Latency
		No. of rising edges of free running PCICLK
CPU_STOP#	0 (disabled)	1
	1 (enabled)	1
PCI_STOP#	0 (disabled)	1
	1 (enabled)	1
PWR_DWN#	1 (normal operation)	3ms
	0 (power down)	2 max.

Notes:

1. Clock on/off latency is defined as the number of rising edges of free running PCICLKs between when the clock disable goes low/high to when the first valid clock comes out of the device.
2. Power up latency is from when PWR_DWN# goes inactive (high) to when the first valid clocks are driven from the device.



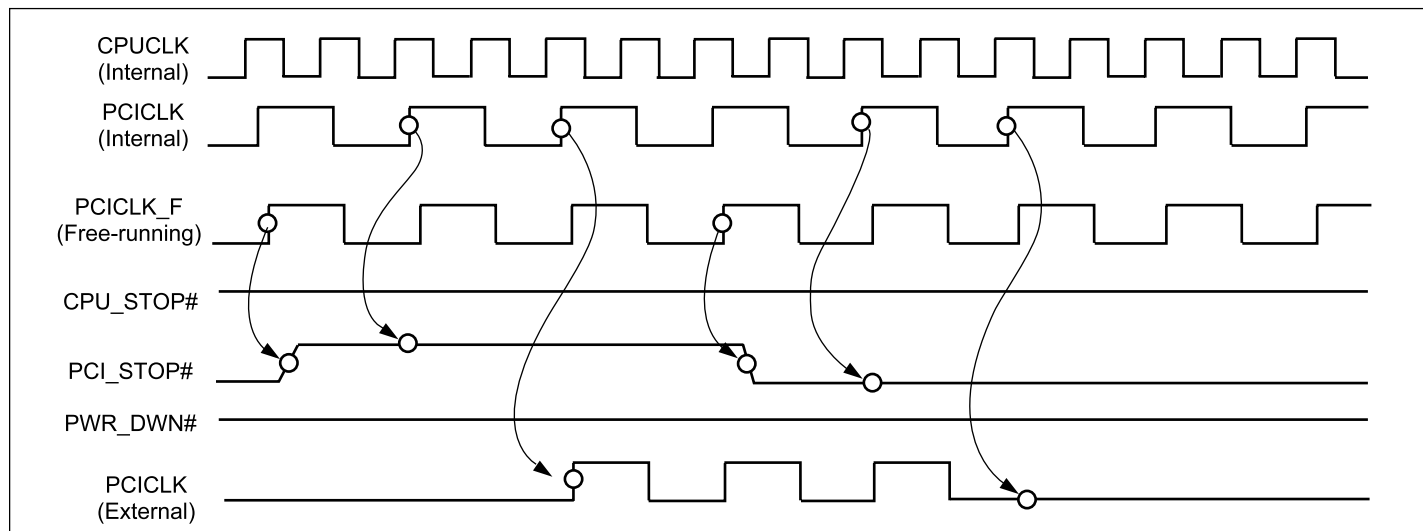
CPU_STOP# Timing Diagram

Notes:

1. All timing is referenced to the CPUCLK.
2. The Internal label means inside the chip and is a reference only.
- 3 CPU_STOP# is an input signal that is made synchronous to the free running PCICLK_F.
4. ON/OFF latency shown is 2 CPU clocks.



PCI_STOP# is an input signal used to turn off the PCI clocks for low power operation. PCI clocks are stopped in the low state and started with a guaranteed full high pulse width. There is ONLY one rising edge of external PCICLK after the clock control logic.

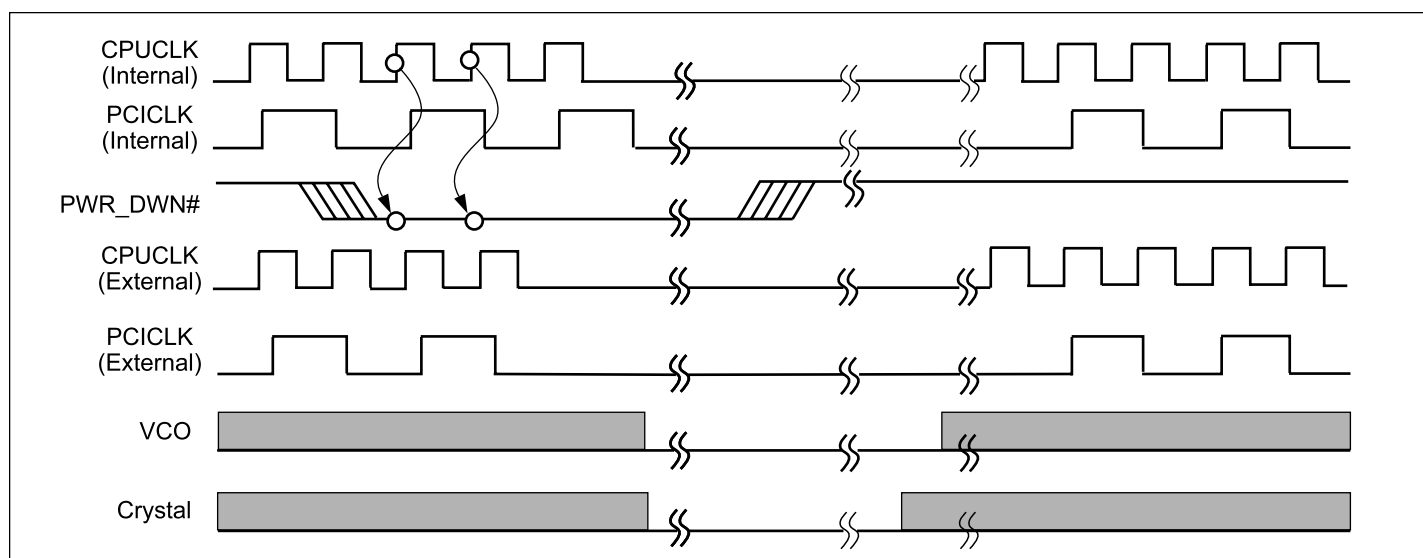


PCI_STOP# Timing Diagram

Notes:

1. All timing is referenced to the CPUCLK.
2. The Internal label means inside the chip and is a reference only.

The PWR_DWN# is used to place the device in a very low power state. PWR_DWN# is an asynchronous active low input. Internal clocks are stopped after the device is put in power down mode. The power on latency is less than 3ms. PCI_STOP# and CPU_STOP# are “don’t cares” during the power down operations. The REF0 clock is stopped in the LOW state as soon as possible.



PWR_DWN# Timing Diagram

Notes:

1. All timing is referenced to the CPUCLK.
2. The Internal label means inside the chip and is a reference only.
3. PWR_DWN# is an asynchronous input and metastable conditions could exist. The signal is synchronized inside the part.
4. The shaded sections on the VCO and the Crystal signals indicate an active clock.



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Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-0°C to +70°C
3.3V Supply Voltage to Ground Potential	-0.5V to +4.6V
2.5V Supply Voltage to Ground Potential	-0.5V to +3.6V
DC Input Voltage	-0.5V to +4.6V

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (V_{DDQ3} = +3.3V ± 5%, V_{DDQ2} = +2.5V ± 5%, T_A = 0°C to +70°C)

Parameters	Description	Test Conditions	Min.	Typ.	Max.	Units
I _{IL}	Input Leakage Current	0V < V _{IN} < V _{DD}	-5		+5	μA
V _{IL}	Input Low Voltage		V _{SS} -0.3		0.8	V
V _{IH}	Input High Voltage	@V _{DD}	+2.0		V _{DD} +0.3	
V _{OL}	Output Low Voltage	I _{OL} = 1mA, V _{DD} = Min.			0.4	
V _{OH}	Output High Voltage	I _{OL} = -1mA, V _{DD} = Min.	2			
I _{DDQ2}	2.5V Supply Current	V _{DDQ2} = 2.625V, PWRDWN#=0 C _{LOAD} = Max.			100	μA
I _{DDQ2}		V _{DDQ2} = 2.625V @ 66.66 MHz C _{LOAD} = Max.			72	mA
I _{DDQ2}		V _{DDQ2} = 2.625V @ 100 MHz C _{LOAD} = Max.			100	
I _{DDQ3}	3.3V Supply Current	V _{DDQ3} = 3.465V, PWRDWN#=0 C _{LOAD} = Max.			500	μA
I _{DDQ3}		V _{DDQ3} = 3.465V, 66.66 MHz C _{LOAD} = Max.			170	mA
I _{DDQ3}		V _{DDQ3} = 3.465V, 100 MHz C _{LOAD} = Max.			170	
C _{IN}	Input Capacitance				5	pF
C _{OUT}	Output Capacitance				6	
L _{PIN}	Pin Conductance				7	nH
T _A	Ambient Temperature	No Airflow	0		70	°C



DC Operating Specifications

Symbol	Parameters	Conditions	Min.	Max.	Units
Input Voltage, VDDCORE [0-1] = 3.3V ± 5%					
V _{IH3}	Input high voltage	V _{DDCORE}	2.0	V _{DDCORE} +0.3	V
V _{IL3}	Input low voltage		V _{SS} -0.3	0.8	
I _{IL}	Input leakage current	0 < V _{IN} < V _{DDCORE}	-5	+5	µA
Output Voltage = 2.5V ± 5% VDDAPIC, VDDCPU [0-1]					
V _{OH2}	Output high voltage	I _{OH} = -1mA	2.0		V
V _{OL2}	Output low voltage	I _{OL} = 1mA		0.4	
Output Voltage = 3.3V ± 5% VDDREF					
V _{OH3}	Output high voltage	I _{OH} = -1mA	2.4		V
V _{OL3}	Output low voltage	I _{OL} = 1mA		0.4	
Output Voltage = 3.3V ± 5% VDDCPI [0-1]					
V _{POH}	PCI Bus output high voltage	I _{OH} = -1mA	2.4		V
V _{POL}	PCI Bus output low voltage	I _{OL} = 1mA		0.55	
C _{IN}	Input pin capacitance			5	pF
C _{XTAL}	X _{TAL} pins capacitance	13.5	18.0	22.5	
C _{OUT}	Output pin capacitance			6	
L _{PIN}	Pin Inductance			7	nH
T _A	Ambient Temperature	No airflow	0	70	°C



Buffer Specifications

Buffer Name	V _{DD} Range(V)	Impedance (Ω)	Buffer Type
CPU	2.375 -2.625	13.5 - 45	Type 1
APIC	2.375 -2.625	9 - 30	Type 2
48MHz, REF	3.135 - 3.465	20 - 60	Type 3
PCI	3.135 - 3.465	12 - 55	Type 4

Type 1: CPU Clock Buffers (2.5V)

Symbol	Parameters	Conditions	Min.	Typ.	Max.	Units
I _{OHMIN}	Pull-up current	V _{OUT} = 1.0V	-27			mA
I _{OHMAX}	Pull-up current	V _{OUT} = 2.375V			-27	
I _{OLMIN}	Pull-down current	V _{OUT} = 1.2V	27			
I _{OLMAX}	Pull-down current	V _{OUT} = 0.3V			30	
t _{RH}	2.5V Type 1 output rise edge rate	2.5V + /-5% @ 0.4V-2.0V	1		4	V/ns
t _{FH}	2.5V Type 1 output fall edge rate	2.5V + /-5% @ 2.0V-0.4V	1		4	

Type 2: APIC Buffers (2.5V)

Symbol	Parameters	Conditions	Min.	Typ.	Max.	Units
I _{OHMIN}	Pull-up current	V _{OUT} = 1.4V	-36			mA
I _{OHMAX}	Pull-up current	V _{OUT} = 2.5V			-21	
I _{OLMIN}	Pull-down current	V _{OUT} = 1.0V	36			
I _{OLMAX}	Pull-down current	V _{OUT} = 0.2V			31	
t _{RH}	2.5V Type 2 output rise edge rate	2.5V $\pm$ 5% @0.4V-2.0V	1		4	V/ns
t _{FH}	2.5V Type 2 output fall edge rate	2.5V $\pm$ 5% @2.0V-0.4V	1		4	

Type 3: 48MHz, REF Buffers (3.3V)

Symbol	Parameters	Conditions	Min.	Typ.	Max.	Units
I _{OHMIN}	Pull-up current	V _{OUT} = 1.0V	-29			mA
I _{OHMAX}	Pull-up current	V _{OUT} = 3.135V			-23	
I _{OLMIN}	Pull-down current	V _{OUT} = 1.95V	29			
I _{OLMAX}	Pull-down current	V _{OUT} = 0.4V			27	
t _{RH}	3.3V Type 3 output rise edge rate	3.3V $\pm$ 5% @0.4V-2.4V	0.5		2	V/ns
t _{FH}	3.3V Type 3 output fall edge rate	3.3V $\pm$ 5% @2.4V-0.4V	0.5		2	



Type 4: PCI Clock Buffers (3.3V)

Symbol	Parameters	Conditions	Min.	Typ.	Max.	Units
I _{OHMIN}	Pull-up current	V _{OUT} = 1.0V	-33			mA
I _{OHMAX}	Pull-up current	V _{OUT} = 3.135V			-33	
I _{OLMIN}	Pull-down current	V _{OUT} = 1.95V	30			
I _{OLMAX}	Pull-down current	V _{OUT} = 0.4V			38	
t _{RH}	3.3V Type 4 output rise edge rate	3.3V ±5% @ 0.4V-2.4V	1		4	V/ns
t _{FH}	3.3V Type 4 output fall edge rate	3.3V ±5% @ 2.4V-0.4V	1		4	

AC Timing

Figure 1. Host Clock to PCI CLK Offset	Parameters	66 MHz		100 MHz		Units
		Min.	Max.	Min.	Max.	
t _{HKP} (2.5V)	Host CLK period	15.0	15.5	10.0	10.5	ns
t _{HKH} (2.5V)	Host CLK high time	5.2		3.0		
t _{HKL} (2.5V)	Host CLK low time	5.0		2.8		
t _{HRISE} (2.5V)	Host CLK rise time	0.4	1.6	0.4	1.6	
t _{HFALL} (2.5V)	Host CLK fall time	0.4	1.6	0.4	1.6	
t _{JITTER} (2.5V)	Host CLK Jitter		250		250	ps
Duty Cycle (2.5V)	Measured at 1.25V	45	55	45	55	%
t _{HSKW} (2.5V)	Host Bus CLK Skew		175		175	ps
t _{IOSKW}	IO APIC Bus CLK Skew		250		250	
t _{PZL} , t _{PZH}	Output enable delay	1.0	8.0	1.0	8.0	ns
t _{PLZ} , t _{PHZ}	Output disable delay	1.0	8.0	1.0	8.0	
t _{HSTB}	Host CLK Stabilization from power-up		3		3	ms
t _{PKP}	PCI CLK period	30.0	∞	30.0	∞	ns
t _{PKPS}	PCI CLK period stability		500		500	ps
t _{PKH}	PCI CLK high time	12.0		12.0		ns
t _{PKL}	PCI CLK low time	12.0		12.0		
t _{PSKW}	PCI Bus CLK Skew		500		500	ps
t _{HPOFFSET}	Host to PCI Clock Offset	1.5	4.0	1.5	4.0	ns
t _{PSTB}	PCI CLK Stabilization from power-up		3		3	ms

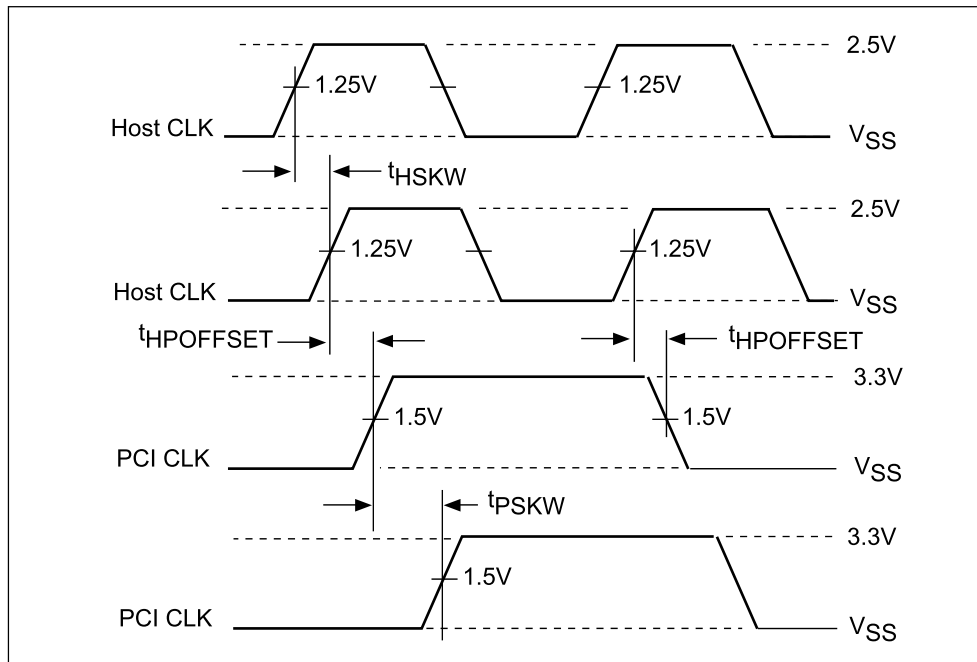


Figure 1. Host Clock to PCI CLK Offset

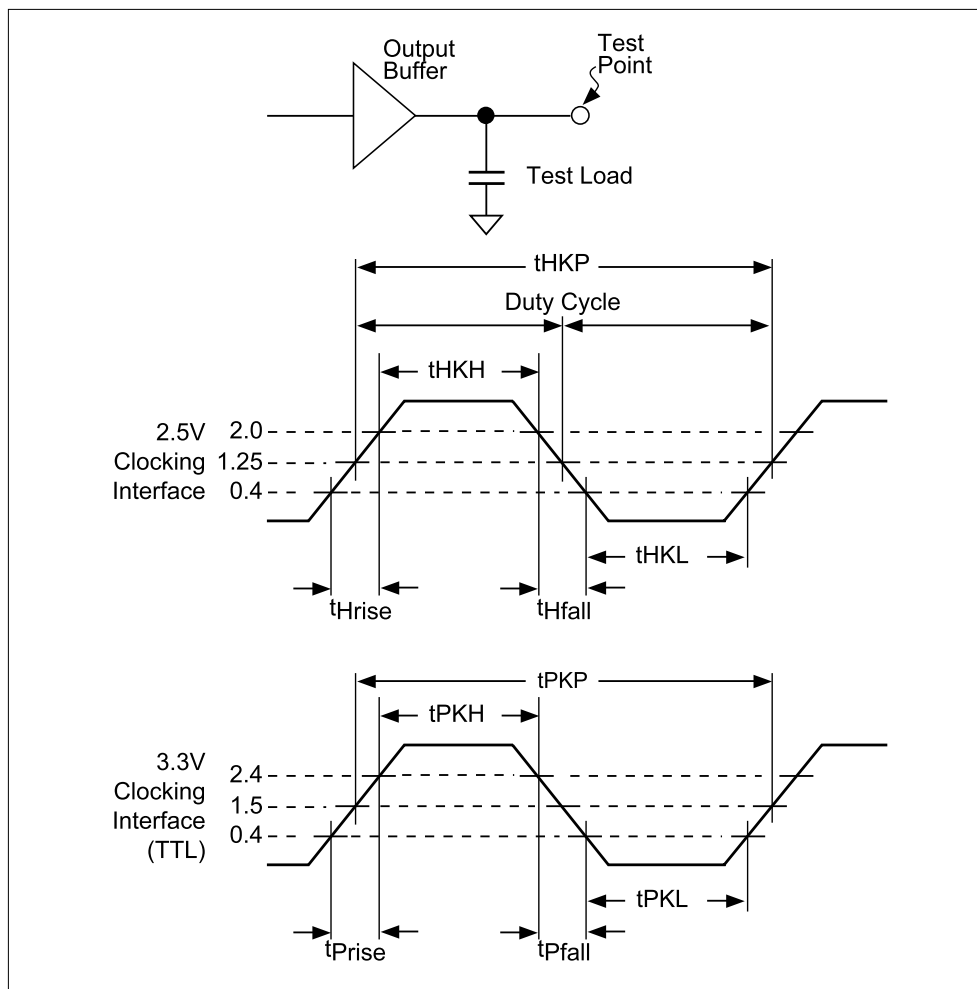


Figure 2. Clock Output Waveforms



Minimum and Maximum Expected Capacitive Loads

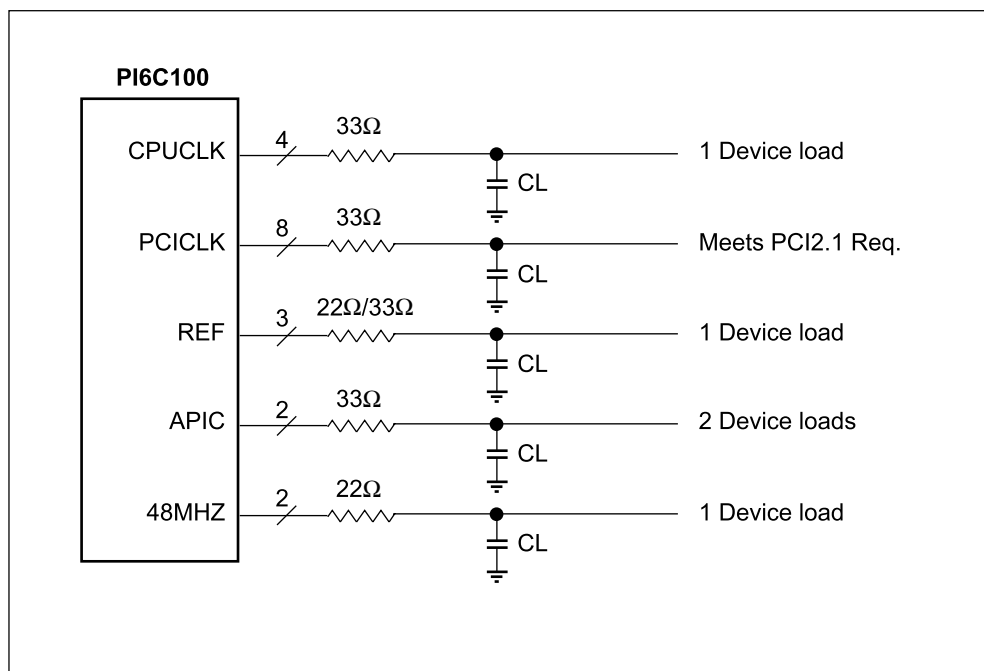
Clock	Min. Load	Max. Load	Units	Notes
CPU Clocks (HCLK)	10	20	pF	1 device load, possible 2 loads
PCI Clocks (PCLK)	30	30		Meets PCI 2.1 requirements
48 MHz Clock	10	20		1 device load
REF	10	20		1 device load
APIC	10	20		2 device loads

Notes:

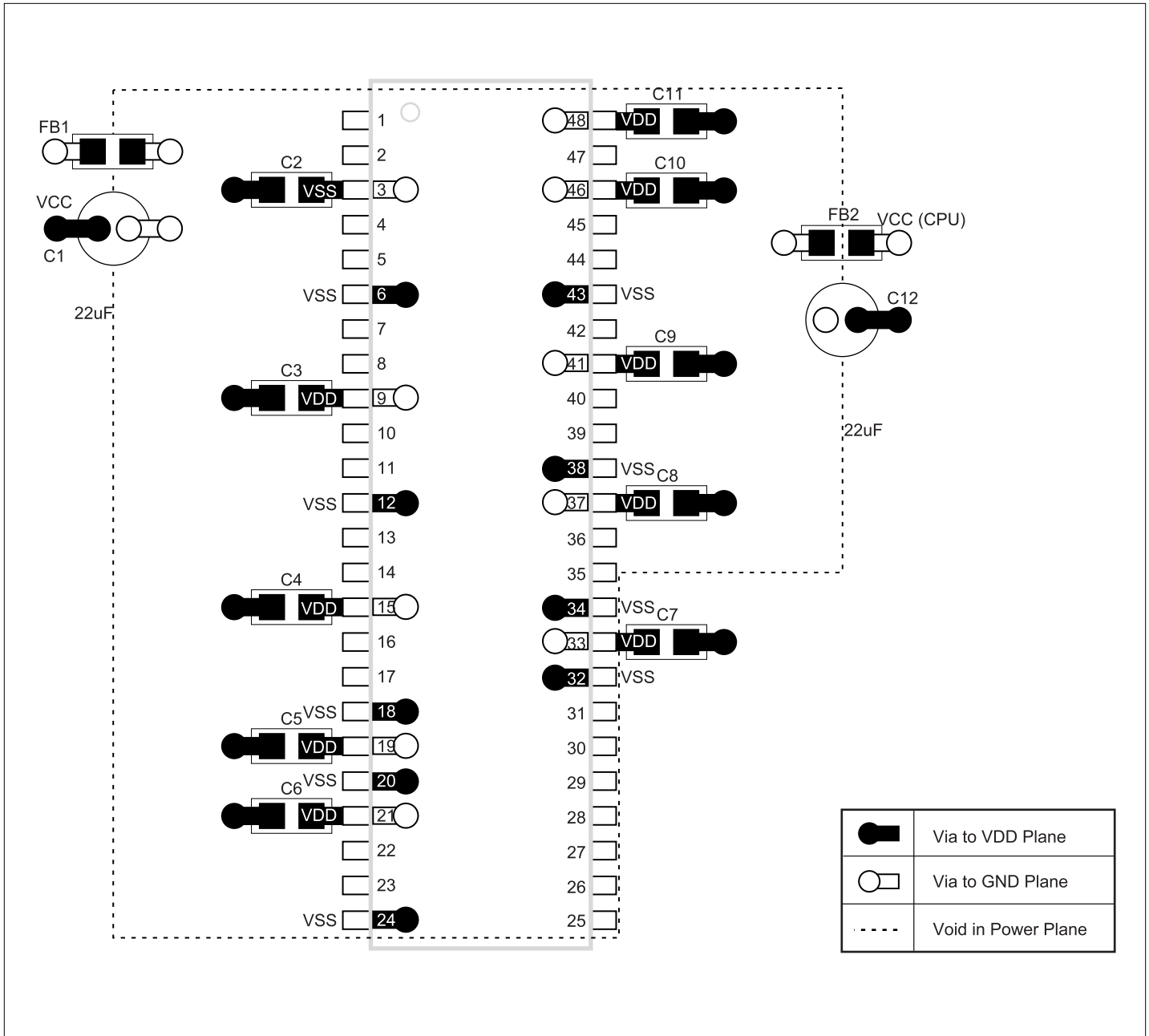
1. Maximum rise/fall times are guaranteed at maximum specified load for each type of output buffer.
2. Minimum rise/fall times are guaranteed at minimum specified load for each type of output buffer.
3. Rise/fall times are specified with pure capacitive load as shown. Testing is done with an additional 500W resistor in parallel.

Design Guidelines to Reduce EMI

1. Place series resistors and CI capacitors as close as possible to the respective clock pins. Typical value for CI is 10pF. Series resistor value can be increased to reduce EMI provided that the rise and fall time are still within the specified values.
2. Minimize the number of “vias” of the clock traces.
3. Route clock traces over a continuous ground plane or over a continuous power plane. Avoid routing clock traces from plane to plane (refer to rule #2).
4. Position clock signals away from signals that go to any cables or any external connectors.



PCB Layout Suggestion



Note:

This is only a suggested layout. There may be alternate solutions depending on actual PCB design and layout.
As a general rule, C2-C11 should be placed as close as possible to their respective V_{DD}.

Recommended capacitor values:

C2-C11 0.1µF, ceramic

C1, C12 22µF



PI6C100 Precision Clock Synthesizer for Desktop PC's

48-Pin SSOP Package Data

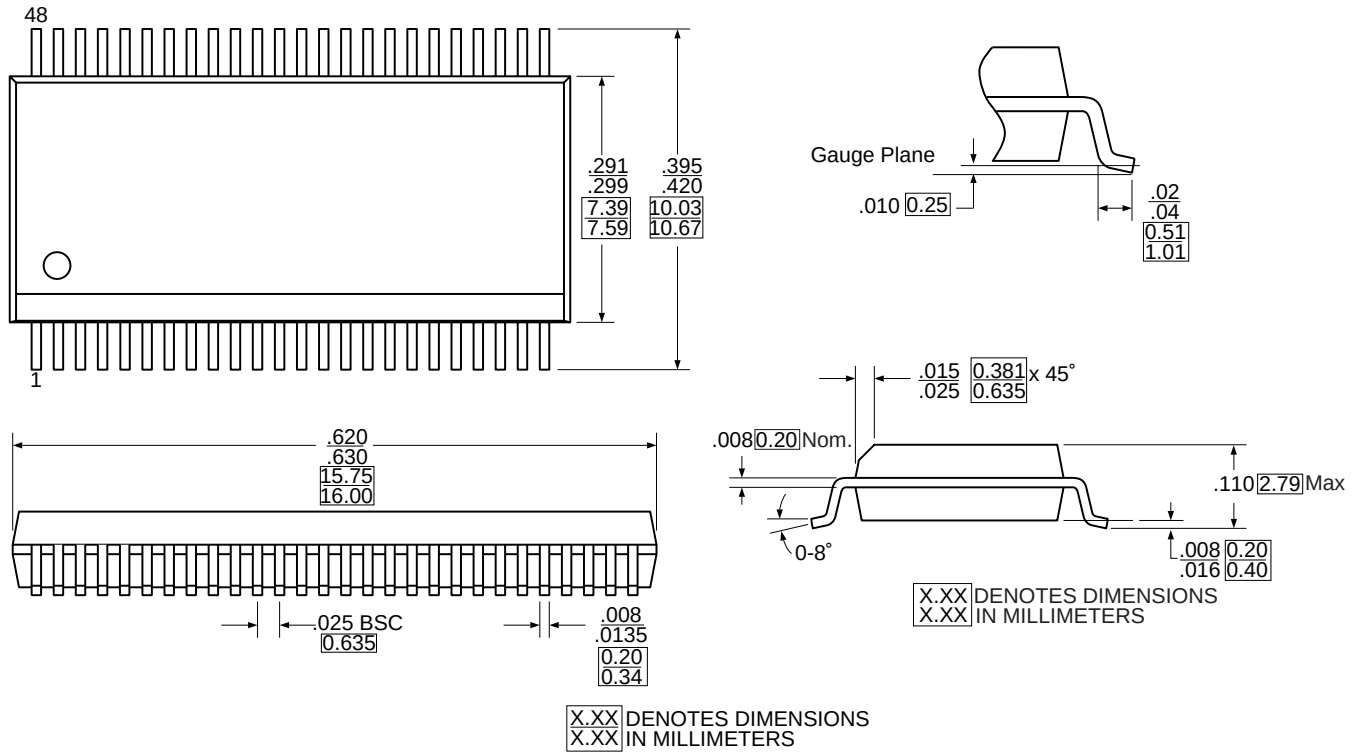


Table of Dimensions

Body		E (Width)	D (Length)	A (Height)	e (Pin-to-Pin pitch)
48 pins	Min.	0.291	0.620	0.095	0.025
(300 mil)	Max.	0.299	0.630	0.110	-

Ordering Information

P/N	Description
PI6C100V	48-pin SSOP Package